GIGAIPC



QBiX-JMB-CFLA310H-A1

Industrial system with Intel® H310 Chipset/support for Intel® 8th/9th Gen Processor / Display Port/ DVI-D port/VGA port/ USB 3.0/2.0/ COM ports/4 GbE LAN ports /M.2 slots

Key Features

- System Size : 224W x 257D x 77H (mm)
- Intel® 9th/8th Gen Processor, TDP 65W
- Dual Channel DDR4, 2 x SO-DIMMs
- DVI-D, D-Sub & DP ports for multiple display
- 4 x GbE LAN ports
- 4 x COM Port
- 8 x USB Port

Application

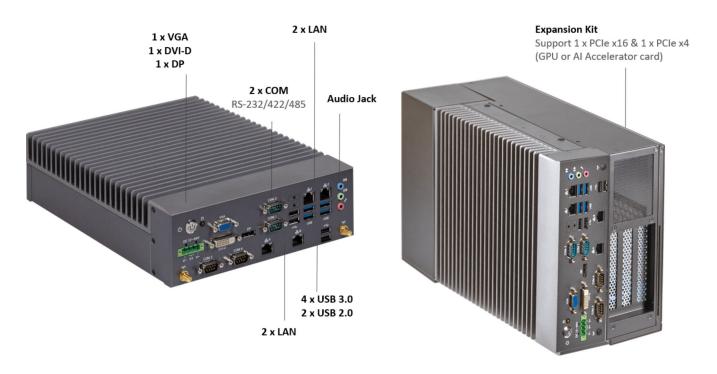
- Factory Automation
- Transportation
- Embedded & Industrial Applications
- Machine Vision
- Edge Computing Applications

SPECIFICATION

QBIX-JMB-CFLA310H-A1 is a high-performance fanless embedded computer featured with Intel® H310 Express Chipset and supported Intel® 8th/9th gen Core™ i processor in LGA1151 package, to provide powerful computing and excellent graphic performance. It's mainly designed for edge computing applications, machine vision, robotic image detection, machine automation, surveillance system in factory, logistics and even healthcare systems, to increase production efficiency.

In addition, it offers 1 x Display Port, 1 x DVI-D port and 1 x VGA port for two independent display outputs, rich I/O interface of 4 x USB 3.0/2.0, 2 x switchable COM ports (RS-232/422/485 & RI/5V/12V), 2 x RS232 COM ports, 4 GbE LAN ports and expantion M.2 slots to connect multiple devices and implement industrial applications. This system supports full range 12-48V DC power inputs for operating temperature of -20°C \sim 50°C. The system supports 2.5" HDD/SSD (SATA 6Gb/s) with vibration resistance of 3 Grms/5 \sim 500Hz and shock endurance to 50G/11ms, to meet industrial standard.

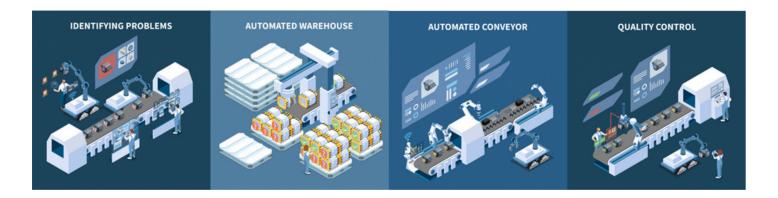
With an optional riser card support, GIGAIPC offers another Machine Vision Solution: **QBIX-JMB-CFLA310HG-A1**, the integration system of **QBIX-JMB-CFLA310H-A1** and discrete GFX card.



QBiX-JMB-CFLA310H-A1

QBiX-JMB-

CFLA310HG-A1



DIMENSION	System Size : 224W x 257D x 91H(mm)
СРИ	Support for 8/9th Generation Intel® Core™ i7/i5/i3 IOTG processors in the LGA1151 package, TDP under 65W
CHIPSET	Intel® H310 Express Chipset
MEMORY	2 x DDR4 SO-DIMM sockets supporting up to 32 GB, Dual channel DDR4 2666/2400 MHz
ETHERNET	1 x GbE LAN ports (Intel® i219V) 3 x GbE LAN ports (Intel® i211AT)
GRAPHIC SUPPORT	Integrated Graphics Processor - Intel® HD Graphics support: 1 x DVI-D port, supporting a maximum resolution of 1920x1080 @60 Hz 1 x D-Sub port, supporting a maximum resolution of 1920x1200 @60 Hz 1 x DP port, supporting a maximum resolution of 4096x2160 @30 Hz 2 independent displays output
AUDIO	Realtek ALC269 with 2W amplifer High Definition Audio
STORAGE	3 x SATA 6 Gb/s port (Support 2.5" HDD/SSD)
EXPANSION SLOTS	1 x M.2 Slot 2230 (E-Key For WiFi+BT) 1 x M.2 Slot 2280 (M-Key support SATA) 1 x Mini-PCle slot (PCleX1+USB2.0) with SIM Slot 1 x PCle slot Discrete riser card support
FRONT I/O	1 x DC IN (4 pin terminal block 12V~48V) 1 x VGA / 1*DVI-D /1*DP 2 x COM (RS-232/422/485 and RI/5V/12V) 2 x COM (RS-232) 4 x RJ45 4 x USB3.0 4 x USB2.0 1 x Audio Jacks (Line in, Line out & Mic in) 4 x External Antenna (optional)
REAR I/O	
POWER	DC in +12V~48Vdc (Full Range)

OPERATION TEMPERATURE	Operating temperature: -20°C to 50°C (CPU 65W TDP) Operating temperature: -20°C to 60°C (CPU 35W TDP) Operating humidity: 0-90% (non-condensing) Non-operating temperature: -40°C to 85°C Non-operating humidity: 0%-95% (non-condensing) Use wide temperature range memory and storage
VIBRATION DURING OPERATION	Operation: IEC 60068-2-64, 3 Grms, random, 5 ~ 500 Hz, 1 hr / Per Axis, With SSD/M.2 2280 Non-operation: IEC 60068-2-6, 2 G, Sine, 10 ~ 500 Hz, 1 Oct/min, 1 hr / Per Axis
SHOCK DURING OPERATION	Operation: IEC 60068-2-27, 50 G, half sine, 11 ms duration, With SSD
PACKAGING CONTENT	Box Packing Capacity: 1 Carton size: 300x315x166(mm) Content: TERMINAL BLOCKS MALE PLUG (25IO0-2ESDV0-D2R)
ORDER INFORMATION	System: 9BQJH310AMR-SI Built in: CPU i3-9100E DDR4 8GB